PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Kuo-wei Hong	09/03/2010
Akira Shimizu	09/03/2010
Kunitoshi Namba	09/03/2010
Woo-Jin Lee	09/03/2010

RECEIVING PARTY DATA

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Street Address:	23-1, 6-chome Nagayama	
City:	Tama-shi, Tokyo	
State/Country:	JAPAN	
Postal Code:	206-0025	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12875889

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	56436.1500
NAME OF SUBMITTER:	Damon L. boyd

Total Attachments: 3

PATENT REEL: 024940 FRAME: 0081 1287 1287

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ASSIGNMENT

WHEREAS, the undersigned inventor(s) (hereinafter singly and collectively, "ASSIGNOR") of the address(es) indicated below, have invented a(n) Method of Forming Conformal Film Having Si-N Bonds on High-Aspect Ratio Pattern for which application for Letters Patent of the United States is being applied for herewith (hereinafter "Application");

AND WHEREAS, ASM Japan K.K. (hereinafter "ASSIGNEE"), a corporation having its principal place of business at Tokyo, Japan and a mailing address of 23-1, 6-chome Nagayama, Tama-shi, Tokyo, Japan 206-0025, is desirous of acquiring the entire right, title, and interest in and to the Application and the invention as described in the Application;

AND WHEREAS, a "formal application," as referred to herein, shall include the Application including any provisional, non-provisional, design, continuation, continuation in part, divisional, reissue, reexamination, foreign, PCT or other patent application or like document thereof,

NOW, THEREFORE, for good and valuable consideration, the receipt and sufficiency of which are hereby acknowledged, ASSIGNOR by these presents do sell, assign and transfer unto ASSIGNEE, its successors, assigns and legal representatives, the full and exclusive right, title, and interest in and to the Applications, the invention as described in the Application, and all formal applications which may be filed based in whole or in part on one or more of the aforesaid applications, in the United States and all foreign countries, together with the right of priority under the International Convention for the Protection of Industrial Property, Inter-American Convention Relating to Patents, Designs and Industrial Models, and any other international agreements to which the United States adheres, and hereby authorizes and requests the Commissioner of Patents to issue said Letters Patent to ASSIGNEE, for the sole use and benefit of ASSIGNEE, its successors, assigns and legal representatives,

AND HEREBY AGREE to transfer, upon request of ASSIGNEE, its successors, assigns and legal representatives, and without further remuneration, a like interest in and to any improvements and formal applications based thereon, growing out of or relating to the invention; and, without further remuneration, to provide all reasonable assistance and execute any papers requested by ASSIGNEE, its successors, assigns and legal representatives, to preserve and/or acquire ASSIGNEE's full protection and title in and to the invention hereby transferred and any improvements therein,

AGREEING, FURTHERMORE, upon request of ASSIGNEE, and without further remuneration, to execute any and all papers desired by ASSIGNEE for the filing and granting of formal applications based on the invention or improvements therein, and the perfecting of title thereto in ASSIGNEE.

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EXECUTED as of the date(s) written below by ASSIGNOR:

11946368

Application No.: 12/875,889 Filed: 9/3/10

INVENTOR'S NAME ADDRESS

SIGNATURE

DATE

Kuo-wei Hong

Tama-Shi, Tokyo

Japan

WITNESS NAME

SIGNATURE

DATE

Junya Moringo

INVENTOR'S NAME ADDRESS

SIGNATURE

DATE

Akira Shimizu

Sagamihara-shi, Kanagawa Japan

WITNESS NAME

SIGNATURE

DATE

Junya Mori moto J. / 20/0/9/3

11946368

-2-

Application No.: 12/875,889

Filed: 9/3/10

難收 野年 2010/9/3 Kunitoshi Namba Machida-shi, Tokyo Japan WITNESS NAME **SIGNATURE** DATE 20/0/9 **INVENTOR'S NAME ADDRESS SIGNATURE DATE** T2/ 20/0/7/3 Woo-Jin Lee Tama-shi, Tokyo Japan WITNESS NAME **SIGNATURE** DATE 20/0/9/3 Junya Morimolo

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RECORDED: 09/03/2010

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